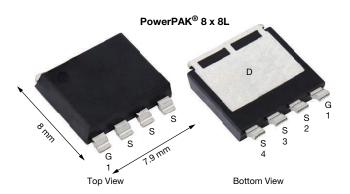
SQJQ184E

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Automotive N-Channel 80 V (D-S) 175 °C MOSFET

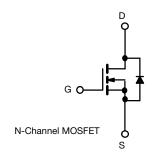


| PRODUCT SUMMARY | |
|--|-----------------|
| V _{DS} (V) | 80 |
| $R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$ | 0.0014 |
| I _D (A) | 430 |
| Configuration | Single |
| Package | PowerPAK 8 x 8L |

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Thin 1.6 mm height
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





| ABSOLUTE MAXIMUM RATING | iS (T _C = 25 °C, unless | otherwise noted |) | | | |
|---|---|-----------------------------------|-------------|------|--|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
| Drain-source voltage | | V _{DS} | 80 | | | |
| Gate-source voltage | | V _{GS} | ± 20 | V | | |
| Continuous drain current T _C = 25 °C | | 1 | 430 | | | |
| Continuous drain current | T _C = 125 °C | I _D | 250 | | | |
| Continuous source current (diode conduction | on) | ۱ _S | 450 | А | | |
| Pulsed drain current ^a | | I _{DM} | 1200 | | | |
| Single pulse avalanche current | L = 0.1 mH | I _{AS} | 65 | | | |
| Single pulse avalanche energy | L = 0.1 MH | E _{AS} | 211 | mJ | | |
| Maximum power dissipation | T _C = 25 °C | Р | 600 | W | | |
| maximum power dissipation | T _C = 125 °C | P _D | 200 | vv | | |
| Operating junction and storage temperature | e range | T _J , T _{stg} | -55 to +175 | °C | | |
| Soldering recommendations (peak temperat | ture) ^c | | 260 | C | | |

| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------|------------------------|-------------------|-------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Junction-to-ambient | PCB mount ^b | R _{thJA} | 40 | °C/W |
| Junction-to-case (drain) | | R _{thJC} | 0.25 | C/ W |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

1

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| SPECIFICATIONS (T _C = 25 °C, u PARAMETER | SYMBOL | | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|------------------------|----------------------------------|---|---------|--------|--------|------|
| Static | STMBOL | 120 | | 141114. | 1/F. | MAA. | |
| Drain-source breakdown voltage | V _{DS} | Vcs | = 0, I _D = 250 μA | 80 | - | - | |
| Gate-source threshold voltage | V _{GS(th)} | | = V _{GS} , I _D = 250 μA | 2 | 3 | 3.5 | V |
| Gate-source leakage | | - | $= 0 \text{ V}, \text{ V}_{\text{GS}} = \pm 20 \text{ V}$ | - | - | ± 100 | nA |
| | 1922 | $V_{GS} = 0 V$ | V _{DS} = 80 V | - | - | 1 | 10.0 |
| Zero gate voltage drain current | I _{DSS} | $V_{GS} = 0 V$ $V_{GS} = 0 V$ | $V_{DS} = 80 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ | - | - | 50 | μA |
| | .033 | $V_{GS} = 0 V$ | V _{DS} = 80 V, T _J = 175 °C | - | - | 500 | μ., |
| On-state drain current ^a | I _{D(on)} | V _{GS} = 10 V | $V_{DS} \ge 5 V$ | 50 | - | - | Α |
| | D(OII) | V _{GS} = 10 V | I _D = 20 A | - | 0.0011 | 0.0014 | - |
| Drain-source on-state resistance ^a | R _{DS(on)} | V _{GS} = 10 V | I _D = 20 A, T _J = 125 °C | - | - | 0.0026 | Ω |
| | | V _{GS} = 10 V | I _D = 20 A, T _J = 175 °C | - | - | 0.0033 | |
| Forward transconductance b | g _{fs} | V _{DS} | = 15 V, I _D = 15 A | - | 82 | - | S |
| Dynamic ^b | | | | | | | |
| Input capacitance | C _{iss} | | | - | 11 435 | 16 010 | |
| Output capacitance | Coss | $V_{GS} = 0 V$ | V _{DS} = 25 V, f = 1 MHz | - | 1896 | 2655 | pF |
| Reverse transfer capacitance | C _{rss} | | | - | 92 | 130 | |
| Total gate charge ^c | Qg | | | - | 181 | 272 | |
| Gate-source charge ^c | Q _{gs} | $V_{GS} = 10 \text{ V}$ | $V_{DS} = 40 \text{ V}, I_D = 50 \text{ A}$ | - | 51 | - | nC |
| Gate-drain charge ^c | Q _{gd} | | | - | 36 | - | |
| Gate resistance | Rg | | f = 1 MHz | 0.7 | 1.3 | 2 | Ω |
| Turn-on delay time ^c | t _{d(on)} | | | - | 21 | 28 | |
| Rise time ^c | t _r | | = 40 V, R _L = 0.8 Ω, | - | 80 | 105 | ns |
| Turn-off delay time ^c | t _{d(off)} | I _D ≅ 50 A, | V_{GEN} = 10 V, R_g = 1 Ω | - | 65 | 85 | 115 |
| Fall time ^c | t _f | | | - | 20 | 28 | |
| Source-Drain Diode Ratings and Charac | teristics ^b | | | | | | |
| Pulsed current ^a | I _{SM} | | | - | - | 1100 | А |
| Forward voltage | V _{SD} | I _F = | 40 A, V _{GS} = 0 V | - | 0.7 | 1.2 | V |
| Body diode reverse recovery time | t _{rr} | | | - | 72 | 144 | ns |
| Body diode reverse recovery charge | Q _{rr} | 1 40 | A di/dt - 100 A /··· | - | 143 | 286 | nC |
| Reverse recovery fall time | t _a | I _F = 10 | A, di/dt = 100 A/µs | - | 41 | - | |
| Reverse recovery rise time | t _b | | | - | 30 | - | ns |
| Body diode peak reverse recovery current | I _{RM(REC)} | | | - | 3.5 | - | А |

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

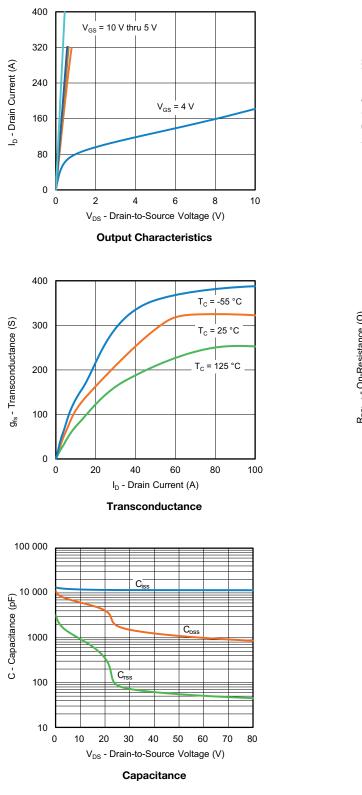
c. Independent of operating temperature

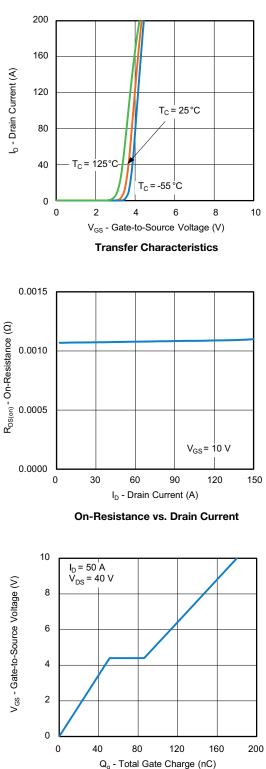
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Gate Charge

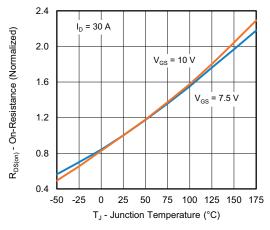
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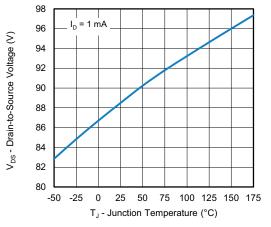
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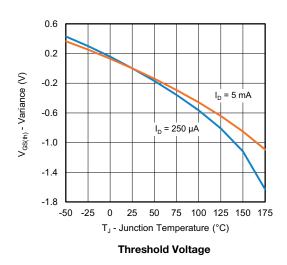
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

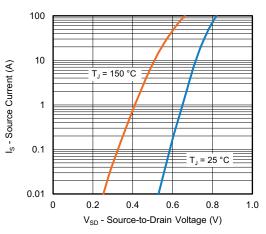


On-Resistance vs. Junction Temperature

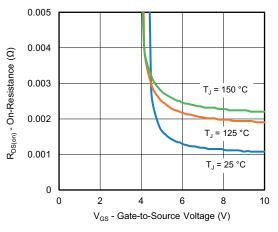


Drain Source Breakdown vs. Junction Temperature

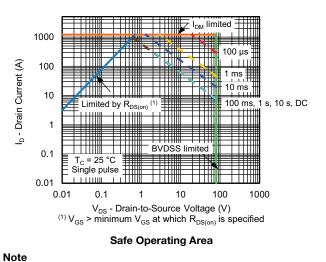




Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

S22-0703-Rev. B, 15-Aug-2022

4 For technical questions, contact: <u>automostechsupport@vishay.com</u> Document Number: 77102

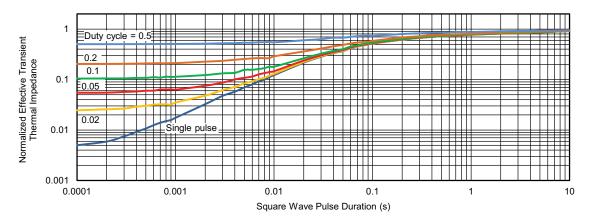
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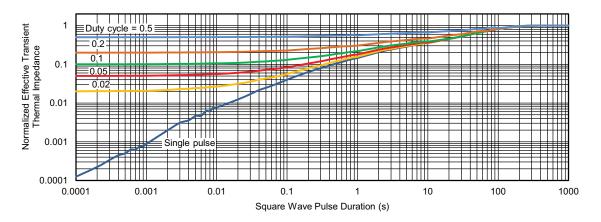
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



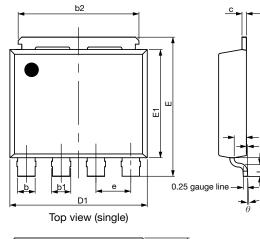
Normalized Thermal Transient Impedance, Junction-to-Ambient

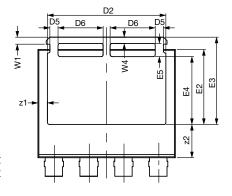
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PowerPAK[®] 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

| 1 | | | | | | _ ↑ |
|---|---|--|---|---|----|------------|
| F | - | | - | - | A. | < |
| l | _ | | | | | |

| DIM. | | MILLIMETERS | | | INCHES | |
|--------------------------|---------------------|-------------|-------|-------|--------|-------|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| А | 1.50 | 1.60 | 1.70 | 0.059 | 0.063 | 0.067 |
| A1 | 0.00 | - | 0.127 | 0.000 | - | 0.005 |
| A2 | 0.655 | 0.705 | 0.755 | 0.026 | 0.028 | 0.030 |
| b | 0.92 | 1.00 | 1.08 | 0.036 | 0.039 | 0.043 |
| b1 | 1.02 | 1.10 | 1.18 | 0.040 | 0.043 | 0.046 |
| b2 | 6.84 | 6.94 | 7.04 | 0.269 | 0.273 | 0.277 |
| С | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 |
| D1 | 7.80 | 7.90 | 8.00 | 0.307 | 0.311 | 0.315 |
| D2 | 6.70 | 6.80 | 6.90 | 0.264 | 0.268 | 0.272 |
| D5 | 0.37 | 0.47 | 0.57 | 0.015 | 0.019 | 0.022 |
| D6 | 2.49 | 2.59 | 2.69 | 0.098 | 0.102 | 0.106 |
| е | 1.97 | 2.00 | 2.03 | 0.078 | 0.079 | 0.080 |
| Е | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 |
| E1 | 6.12 | 6.22 | 6.32 | 0.241 | 0.245 | 0.249 |
| E2 | 4.21 | 4.31 | 4.41 | 0.166 | 0.170 | 0.174 |
| E3 | 4.92 | 5.02 | 5.12 | 0.194 | 0.198 | 0.202 |
| E4 | 3.80 | 3.90 | 4.00 | 0.150 | 0.154 | 0.157 |
| E5 | 0.65 | 0.75 | 0.85 | 0.026 | 0.030 | 0.033 |
| L | 0.61 | 0.68 | 0.75 | 0.024 | 0.027 | 0.030 |
| L1 | 1.00 | 1.07 | 1.15 | 0.039 | 0.042 | 0.045 |
| W1 | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 |
| W4 | 0.32 | 0.37 | 0.42 | 0.013 | 0.015 | 0.017 |
| z1 | 0.45 | 0.55 | 0.65 | 0.018 | 0.022 | 0.026 |
| z2 | 1.81 | 1.91 | 2.01 | 0.071 | 0.075 | 0.079 |
| θ | 0° | - | 5° | 0° | - | 5° |
| N: S19-0643-F G: 6073 | lev. B, 05-Aug-2019 | | | | | |

Note

• Millimeter will govern

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